

	COLOR: (2) PIN MATERIAL: F (3) TO DETERMINE I N = NUMBER O EXAMPLE: 10 PC (4) 2LBS/0.9KG MIN 5. PACKAGED IN PC (6) RETENTIVE LEG 5LB/2.3KG MAX PER RETENTIVE I HOLE PATTERN. OMIT FROM PRO (7) FOR POLARIZATIC TO OMIT FIN. OMIT FROM PRO 8. UNDERPLATING:	HOSPHOR-BRONZE DIMENSIONS: F POSITIONS PER ROW. DS., N × .100[2.54]=1.00[25.40]. . PIN RETENTION IN EITHER DIRECTION DLY BAGS APPLICABLE TO TAIL LENGTH .120/3.05 ONLY. INSERTION FORCE AND .25LB./1KG MIN RETENTION FORCE PIN USING .062/1.57 THICK CIRCUIT BOARD AND RECOMMENDED RETENTIVE LOCATION AT THE DISCRETION OF THE MANUFACTURER. DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. DN SPECIFY POSITION NUMBER(i.e A03=ROW A POS 3) DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE.
	COLOR: (2) PIN MATERIAL: F (3) TO DETERMINE I N = NUMBER O EXAMPLE: 10 PC (4) 2LBS/0.9KG MIN 5. PACKAGED IN PC (6) RETENTIVE LEG 5LB/2.3KG MAX PER RETENTIVE I HOLE PATTERN. OMIT FROM PRO (7) FOR POLARIZATIC TO OMIT FIN. OMIT FROM PRO 8. UNDERPLATING:	FLAME RETARDANT PER UL 94V-0 BLACK HOSPHOR-BRONZE DIMENSIONS: F F POSITIONS PER ROW. DS., N × .100[2.54]=1.00[25.40]. . . . PIN RETENTION IN EITHER DIRECTION DLY BAGS A APPLICABLE TO TAIL LENGTH .120/3.05 ONLY. . . INSERTION FORCE AND .25LB./1KG MIN RETENTION FORCE . . . PIN USING .062/1.57 THICK CIRCUIT BOARD AND RECOMMENDED . . . DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. . . . DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. . . . DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. . . . DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. . . . DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. . . . DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. . . . DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. . . .
	 TO DETERMINE I N = NUMBER O EXAMPLE: 10 PC (4) 2LBS/0.9KG MIN 5. PACKAGED IN PC (6) RETENTIVE LEG 5LB/2.3KG MAX PER RETENTIVE I HOLE PATTERN. OMIT FROM PRO (7) FOR POLARIZATIC TO OMIT FIN. OMIT FROM PRO 8. UNDERPLATING: 	DIMENSIONS: F POSITIONS PER ROW. SS., N × .100[2.54]=1.00[25.40]. . PIN RETENTION IN EITHER DIRECTION DLY BAGS APPLICABLE TO TAIL LENGTH .120/3.05 ONLY. INSERTION FORCE AND .25LB./1KG MIN RETENTION FORCE PIN USING .062/1.57 THICK CIRCUIT BOARD AND RECOMMENDED RETENTIVE LOCATION AT THE DISCRETION OF THE MANUFACTURER. DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. DN SPECIFY POSITION NUMBER(i.e A03=ROW A POS 3) DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. 50µ"/1.27µm Ni.
	N = NUMBER O EXAMPLE: 10 PC (4) 2LBS/0.9KG MIN 5. PACKAGED IN PC (6) RETENTIVE LEG 5LB/2.3KG MAX PER RETENTIVE I HOLE PATTERN. OMIT FROM PRO (7) FOR POLARIZATIC TO OMIT FIN. OMIT FROM PRO 8. UNDERPLATING:	F POSITIONS PER ROW. A DS., N × .100[2.54]=1.00[25.40]. A . PIN RETENTION IN EITHER DIRECTION A DLY BAGS A APPLICABLE TO TAIL LENGTH .120/3.05 ONLY. INSERTION FORCE AND .25LB./1KG MIN RETENTION FORCE PIN USING .062/1.57 THICK CIRCUIT BOARD AND RECOMMENDED RETENTIVE LOCATION AT THE DISCRETION OF THE MANUFACTURER. DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. DN SPECIFY POSITION NUMBER(i.e A03=ROW A POS 3) DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. 50 µ"/1.27 µm Ni.
	5. PACKAGED IN PC 6 RETENTIVE LEG 5LB/2.3KG MAX PER RETENTIVE I HOLE PATTERN. OMIT FROM PRO 7 FOR POLARIZATIO TO OMIT PIN. OMIT FROM PRO 8. UNDERPLATING:	DLY BAGS A APPLICABLE TO TAIL LENGTH .120/3.05 ONLY. INSERTION FORCE AND .25LB./1KG MIN RETENTION FORCE PIN USING .062/1.57 THICK CIRCUIT BOARD AND RECOMMENDED RETENTIVE LOCATION AT THE DISCRETION OF THE MANUFACTURER. DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. DN SPECIFY POSITION NUMBER(i.e A03=ROW A POS 3) DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. 50 µ"/1.27 µm Ni.
	 (6) RETENTIVE LEG , 5LB/2.3KG MAX PER RETENTIVE I HOLE PATTERN. OMIT FROM PRO (7) FOR POLARIZATIO TO OMIT PIN. OMIT FROM PRO 8. UNDERPLATING: 	APPLICABLE TO TAIL LENGTH .120/3.05 ONLY. INSERTION FORCE AND .25LB./1KG MIN RETENTION FORCE PIN USING .062/1.57 THICK CIRCUIT BOARD AND RECOMMENDED RETENTIVE LOCATION AT THE DISCRETION OF THE MANUFACTURER. DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. DN SPECIFY POSITION NUMBER(i.e., A03=ROW A POS 3) DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. 50µ"/1.27µm Ni.
\bigcirc	PER RETENTIVE HOLE PATTERN. OMIT FROM PRO OF POLARIZATIO TO OMIT PIN. OMIT FROM PRO 8. UNDERPLATING:	PIN USING .062/1.57 THICK CIRCUIT BOARD AND RECOMMENDED RETENTIVE LOCATION AT THE DISCRETION OF THE MANUFACTURER. DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. DN SPECIFY POSITION NUMBER(i.e., A03=ROW A POS 3) DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. 50µ"/1.27µm Ni.
\bigcirc	TO OMIT PIN. OMIT FROM PRO 8. UNDERPLATING:	DUCT NUMBER IF THIS FEATURE IS NOT APPLICABLE. 50µ"/1.27µm Ni.
	OMIT FROM PRO 8. UNDERPLATING:	50μ"/1.27μm Ni.
	TWO SIDES, BOT	H ENDS.
		WITH "LF" SUFFIX AT THE END ARE LEAD FREE.
В		IEETS EUROPEAN UNION DIRECTIVES AND OTHER ITION AS DESCRIBED IN GS-22-008.
FClconnect.com	FOR 20 SECOND OVEN. SEE APPLI FOR 15 SECOND MINIMUM THICK ((3). "THIS PRODUCT	ILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE S IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW CATION NOTES/PROCEDURES IF THEY ARE AVAILABLE OR S IN A WAVE SOLDER APPLICATION WITH A 1.5mm CIRCUIT BOARD. HAS 100% PURE TIN PLATING IN THE INTERFACE AND TESTED FOR WHISKER GROWTH IN ALL INTERCONNECT
<u>c</u>	.100 ±.003 2.54 ±0.08 2.54 ±0.08 2.54 ±0.08	c
EC	↓ ↓ ↓ ↓ ↓ 0.040±.003	mat'l. code surface /tolerance projection product family
ight	TYP RECOMMENDED HOLE PATTERN	ISO 1302 V ISO 406 ISO 1101 Itr ecn no dr date tolerances unless otherwise specified title
Copyright		G angles Xx±.01/0.3 INCH/MM .100 UNSHROUDED HDR.
		dr D.INGRAM 05/20/99 DWg no sheet 2 of 2 size
\bigcirc		engr H.SUNDY 07/21/99 chr H.SUNDY 07/21/99 55102 A3
		sheet revision H.SUNDY 07/21/99 Y type Product Customer Drawing
D form: A		index sheet D D D 3 4 5 6

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